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(22)Date of 12.06.2000  
filing :(72)Inventor : WASHIMI AKIRA  
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KIMURA KAORU**(54) PROCESSED WOODY MATERIAL**

(57)Abstract:

**PROBLEM TO BE SOLVED:** To provide a processed woody material such as a woody board, compacted wood, a woody laminate and the like which is free from emission of formaldehyde and excellent in heat resistance and dimensional stability for humidity variation.

**SOLUTION:** The processed woody material contains a hardened material of a resin composition comprising maleimide compound and methallyl phenol compound or methallyl phenyl ether compound.

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## CLAIMS

[Claim(s)]

[Claim 1] Processing wood quality material characterized by containing the hardened material of the resin constituent which consists of a maleimide compound, a metalyl phenolic compound, or a metalyl phenyl ether compound.

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